



AFE1224

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2Mbps, Single Pair ANALOG FRONT END

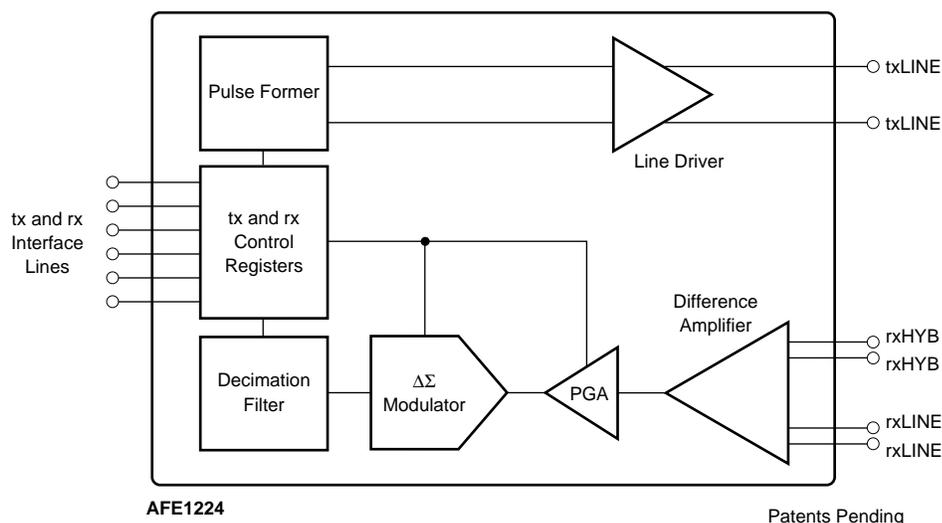
FEATURES

- E1/T1 SINGLE PAIR 2B1Q
- PROGRAMMABLE POWER DISSIPATION
- 28-LEAD SSOP
- 64kbps TO 2320kbps OPERATION
- SCALEABLE DATA RATE
- PIN COMPATIBLE WITH AFE1124
- COMPLETE ANALOG INTERFACE
- -40°C TO $+85^{\circ}\text{C}$ OPERATION

DESCRIPTION

Burr-Brown's Analog Front End minimizes the size and cost of a single pair High bit rate Digital Subscriber Line (HDSL) system by providing all of the active analog circuitry needed to connect an HDSL digital signal processor to an external compromise hybrid and an HDSL line transformer. The transmit and receive filter responses automatically change with clock frequency, allowing the AFE1224 to operate over a wide range of data rates. The power dissipation of the device can be reduced under digital control for operation at lower speeds. The AFE1224 will operate at bit rates from 64kbps to 2.320Mbps.

Functionally, this unit consists of a transmit and a receive section. The transmit section generates analog signals from 2-bit digital symbol data and filters the analog signals to create 2B1Q symbols. The on-board differential line driver provides a 13.5dBm signal to the telephone line. The receive section filters and digitizes the symbol data received on the telephone line. The AFE1224 operates on a single 5V supply. The digital circuitry in the unit can be connected to a supply from 3.3V to 5V. The chip uses only 355mW for full-speed operation. It is housed in a 28-lead SSOP package.



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SPECIFICATIONS

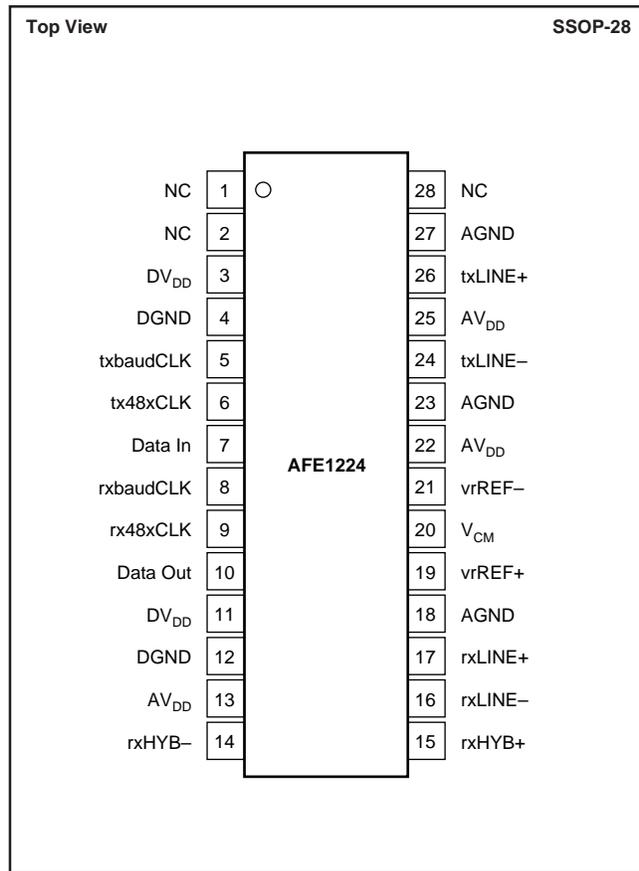
All specifications at 25°C, AV_{DD} = +5V, DV_{DD} = +3.3V, f_{TX} = 1168kHz (E1 rate) and normal power mode, unless otherwise noted.

PARAMETER	COMMENTS	AFE1224E			UNITS
		MIN	TYP	MAX	
RECEIVE CHANNEL					
Number of Inputs	Differential	2			
Input Voltage Range	Balanced Differential ⁽¹⁾		±3.0		V
Common-Mode Voltage			AV _{DD} /2		V
Input Impedance, All Inputs					
78kbps			32		kΩ
1168kbps			21		kΩ
2320kbps			10		kΩ
Input Capacitance			10		pF
Input Gain Matching	Line Input vs Hybrid Input		±2		%
Resolution		14			Bits
Programmable Gain	0dB, 3dB, 6dB, 9dB and 12dB	0		+12	dB
Settling Time for Gain Change			6		Symbol Periods
Gain + Offset Error	Tested at Each Gain Range		5		%FSR ⁽²⁾
Output Data Coding			Binary Two's Complement		
Data Rate	Normal Power	64		2320	kbps
	Medium Power	64		1168	kbps
	Low Power	64		320	kbps
Output Word Rate	Normal Power ⁽³⁾	32		1168	kHz
TRANSMIT CHANNEL					
Transmit Clock Rate, f _{TX}	Symbol Rate, Normal Power	196		1168	kHz
	Symbol Rate, Medium Power	96		584	kHz
	Symbol Rate, Low Power	80		160	kHz
Transmit -3dB Point	2320kbps		485		kHz
	1168kbps		292		kHz
	784kbps		196		kHz
Transmit Power ⁽⁵⁾		13	13.5	14	dBm
Pulse Output		See Typical Performance Curves			
Common-Mode Voltage (V _{CM})			AV _{DD} /2		V
Output Resistance	DC to 1MHz		1		Ω
TRANSCEIVER PERFORMANCE					
Uncancelled Echo ⁽⁵⁾	rxGAIN = 0dB, Loopback Enabled		-71	-68.5	dB
	rxGAIN = 0dB, Loopback Disabled		-71	-68.5	dB
	rxGAIN = 3dB, Loopback Disabled		-74	-71	dB
	rxGAIN = 6dB, Loopback Disabled		-76	-73.5	dB
	rxGAIN = 9dB, Loopback Disabled		-78	-75.5	dB
	rxGAIN = 12dB, Loopback Disabled		-80	-77.5	dB
DIGITAL INTERFACE					
Logic Levels					
V _{IH}	I _{IH} < 10μA	DV _{DD} -1		DV _{DD} +0.3	V
V _{IL}	I _{IL} < 10μA	-0.3		+0.8	V
V _{OH}	I _{OH} = -20μA	DV _{DD} -0.5			V
V _{OL}	I _{OL} = 20μA			+0.4	V
t _{rx1} Interface		3		4.6	ns
POWER					
Analog Power Supply Voltage	Specification		5		V
	Operating Range	4.75		5.25	V
Digital Power Supply Voltage	Specification		3.3		V
	Operating Range	3.15		5.25	V
Power Dissipation ^(4, 5)	Normal Power		385		mW
	Medium Power		300		mW
	Low Power		240		mW
Power Dissipation ^(4, 5)	Normal Power, DV _{DD} = 5V		415		mW
Power Supply Rejection Ratio			55		dB
TEMPERATURE RANGE					
Operating ⁽⁶⁾		-40		+85	°C

NOTES: (1) With a balanced differential signal, the positive input is 180° out-of-phase with the negative input, therefore the actual voltage swing about the common-mode voltage on each pin is ±1.5V to achieve a total input range of ±3.0V or 6Vp-p. (2) FSR is Full-Scale Range. (3) The output data is available at twice the symbol rate with interpolated values. (4) With a pseudo-random equiprobable sequence of HDLSL pulses; 13.5dBm applied to the transformer (16.5dBm output from txLINE+ and txLINE-). (5) See the Discussion of Specifications section of this data sheet for more information. (6) Functionality only guaranteed over temperature range.

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PIN CONFIGURATION



PIN DESCRIPTIONS

PIN #	TYPE	NAME	DESCRIPTION
1	—	NC	No Connection
2	—	NC	No Connection
3	Power	DV _{DD}	Digital Supply (+3.3 to +5V)
4	Ground	DGND	Digital Ground
5	Input	txbaudCLK	Transmit Baud Clock
6	Input	tx48xCLK	Transmit Clock at 48x Baud Clock
7	Input	Data In	Input Data Word
8	Input	rxbaudCLK	Receive Baud Clock
9	Input	rx48xCLK	Receive Clock at 48x Baud Clock
10	Output	Data Out	Output Data Word
11	Power	DV _{DD}	Digital Supply (+3.3V to +5V)
12	Ground	DGND	Digital Ground
13	Power	AV _{DD}	Analog Supply (+5V)
14	Input	rxHYB-	Negative Input from Hybrid Network
15	Input	rxHYB+	Positive Input from Hybrid Network
16	Input	rxLINE-	Negative Line Input
17	Input	rxLINE+	Positive Line Input
18	Ground	AGND	Analog Ground
19	Output	vrREF+	Positive Reference Output
20	Output	V _{CM}	Common-Mode Voltage (buffered)
21	Output	vrREF-	Negative Reference Output
22	Power	AV _{DD}	Analog Supply (+5V)
23	Ground	AGND	Analog Ground
24	Output	txLINE-	Negative Line Output
25	Power	AV _{DD}	Output Buffer Supply (+5V)
26	Output	txLINE+	Positive Line Output
27	Ground	AGND	Output Buffer Ground
28	—	NC	No Connection

ABSOLUTE MAXIMUM RATINGS

Analog Inputs: Current	±100mA, Momentary ±10mA, Continuous
Voltage	AGND -0.3V to AV _{DD} +0.3V
Analog Outputs Short Circuit to Ground (+25°C)	Continuous
AV _{DD} to AGND	-0.3V to 6V
DV _{DD} to DGND	-0.3V to 6V
Digital Input Voltage to DGND	-0.3V to DV _{DD} +0.3V
Digital Output Voltage to DGND	-0.3V to DV _{DD} +0.3V
AGND, DGND, Differential Voltage	0.3V
Junction Temperature (T _J)	+150°C
Storage Temperature Range	-40°C to +125°C
Lead Temperature (soldering, 3s)	+260°C
Power Dissipation	700mW



ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

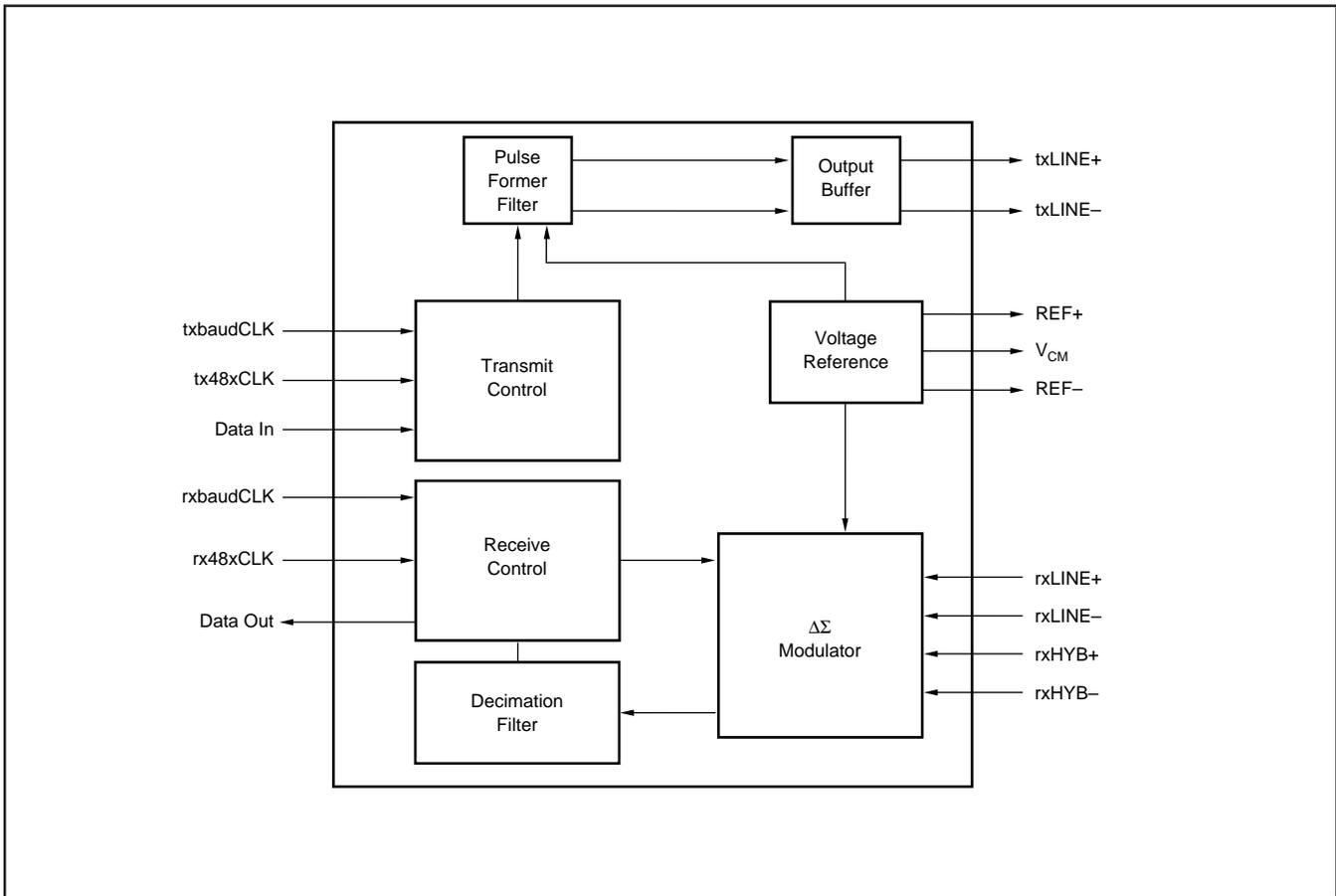
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER ⁽²⁾	TRANSPORT MEDIA
AFE1224E	SSOP-28	324	-40°C to +85°C	AFE1224E	AFE1224E	Rails
"	"	"	"	"	AFE1224E/1K	Tape and Reel

NOTES: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book. (2) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /1K indicates 1000 devices per reel). Ordering 1000 pieces of "AFE1224E/1K" will get a single 1000-piece Tape and Reel. For detailed Tape and Reel mechanical information, refer to Appendix B of Burr-Brown IC Data Book.

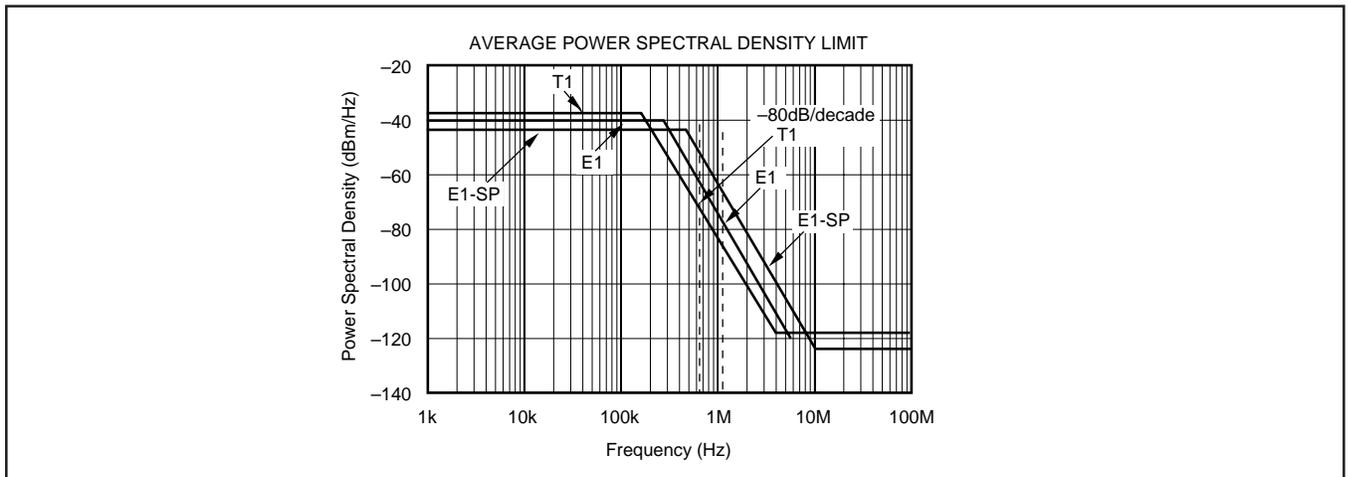
BLOCK DIAGRAM



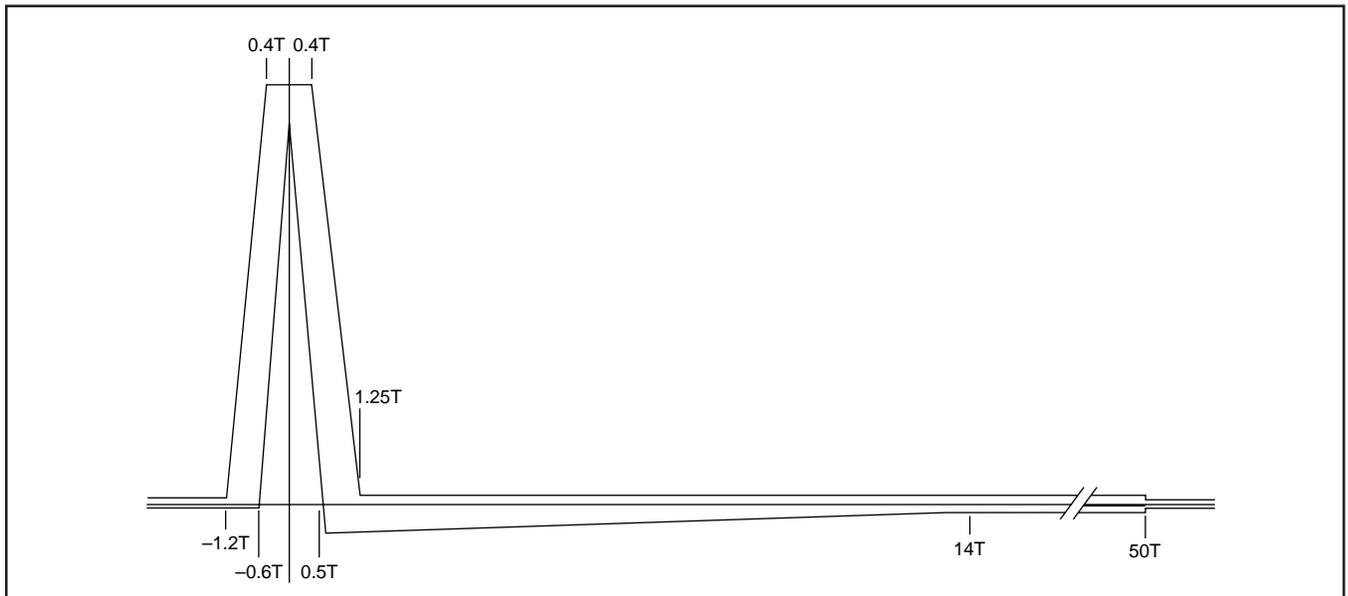
TYPICAL PERFORMANCE CURVES

At Output of HDSL Pulse Transformer

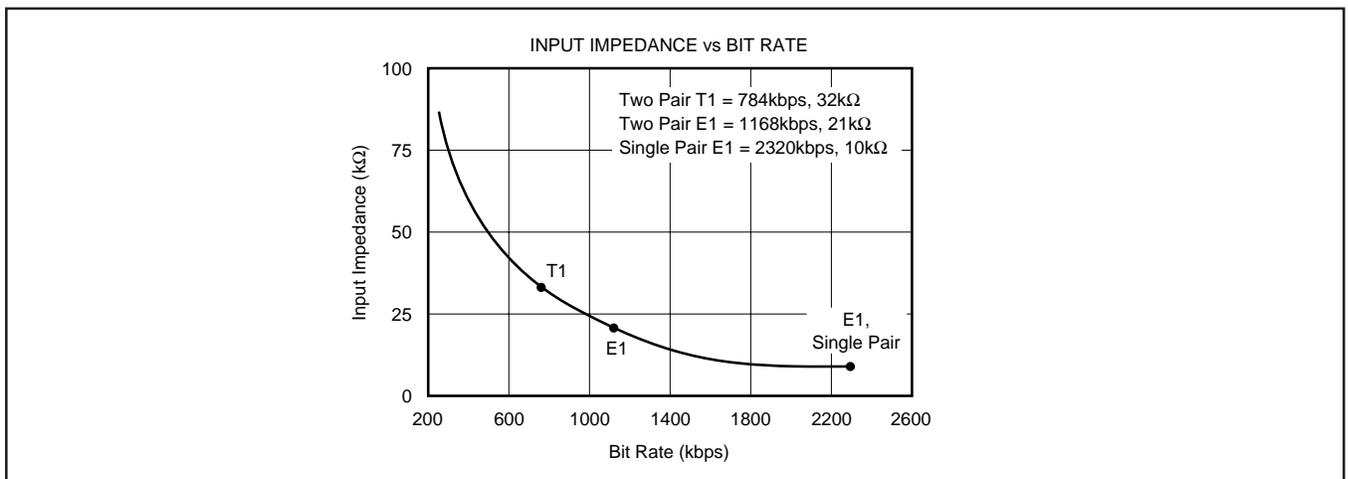
The curves shown below are measured at the line output of the HDSL transformer. Typical at 25°C, $AV_{DD+} = +5V$, $DV_{DD+} = +3.3V$, and $f_{TX} = 1168kHz$, unless otherwise specified.



CURVE 1. Upper Bound of Power Spectral Density Measured at Output of HDSL Transformer.



CURVE 2. Transmitted Pulse Template Measured at HDSL Transformer Output.



CURVE 3. Input Impedance of rxLINE and rxHYB.

THEORY OF OPERATION

The AFE1224 consists of a transmit and a receive channel. It interfaces to the HDSL DSP through a six wire serial interface, three wires for the transmit channel and three wires for the receive channel. It interfaces to the HDSL telephone line transformer and external compromise hybrid through transmit and receive analog connections.

The transmit channel consists of a digital-to-analog converter and a switched-capacitor pulse forming network followed by a differential line driver. The pulse forming network receives 2-bit digital symbol data and generates a filtered 2B1Q analog output waveform. The differential line driver uses a composite output stage combining class B operation (for high efficiency driving large signals) with class AB operation (to minimize crossover distortion).

The receive channel is designed around a fourth-order delta sigma A/D converter. It includes a difference amplifier designed to be used with an external compromise hybrid for first order analog echo cancellation. A programmable gain amplifier with gains of 0dB to +12dB is also included. The delta-sigma modulator operating at a 24x oversampling ratio produces a 14-bit output at rates up to 584kHz (1.168Mbps). The receive channel operates by summing the two differential inputs, one from the line (rxLINE) and the other from the

compromise hybrid (rxHYB). The connection of these two inputs so that the hybrid signal is subtracted from the line signal is described in the paragraph titled "Echo Cancellation in the AFE." The equivalent gain for each input in the difference amp is one. The resulting signal then passes to a programmable gain amplifier which can be set for gains of 0dB through +12dB. Following the PGA, the ADC converts the signal to a 14-bit digital word.

The serial interface consists of three wires for transmit and three wires for receive. The three-wire transmit interface is transmit baud rate clock, transmit 48x oversampling clock and Data Out. The three-wire receive interface is receive baud rate clock, receive 48x oversampling clock and Data In. The transmit and receive clocks are supplied to the AFE1224 from the DSP and are completely independent.

DIGITAL DATA INTERFACE

Data is received by the AFE1224 from the DSP on the Data In line. Data is transmitted from the AFE1224 to the DSP on the Data Out line. The paragraphs below describe the timing of these signals and data structure.

Data is transmitted and received in synchronization with the 48x transmit and receive clocks (tx48xCLK and rx48xCLK). There are 48-bit times in each baud period. Data In is

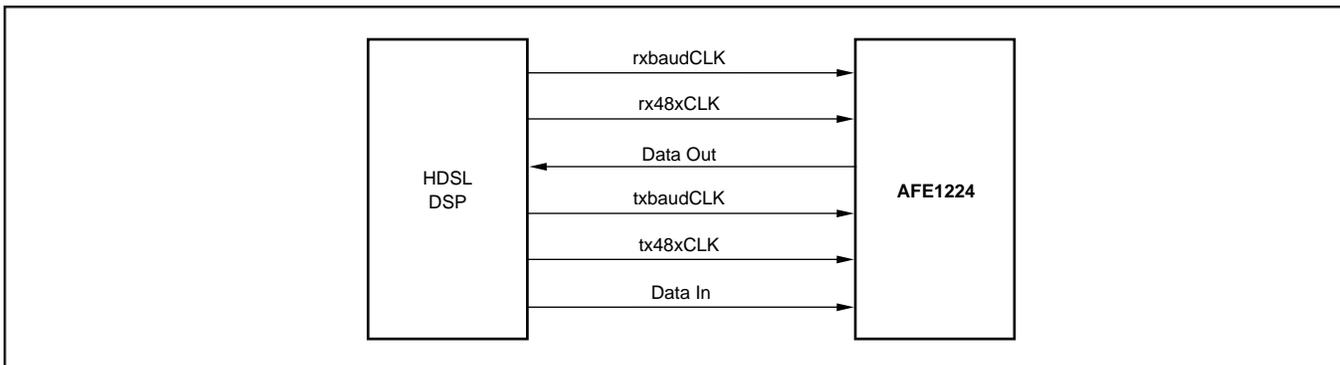


FIGURE 1. DSP Interface.

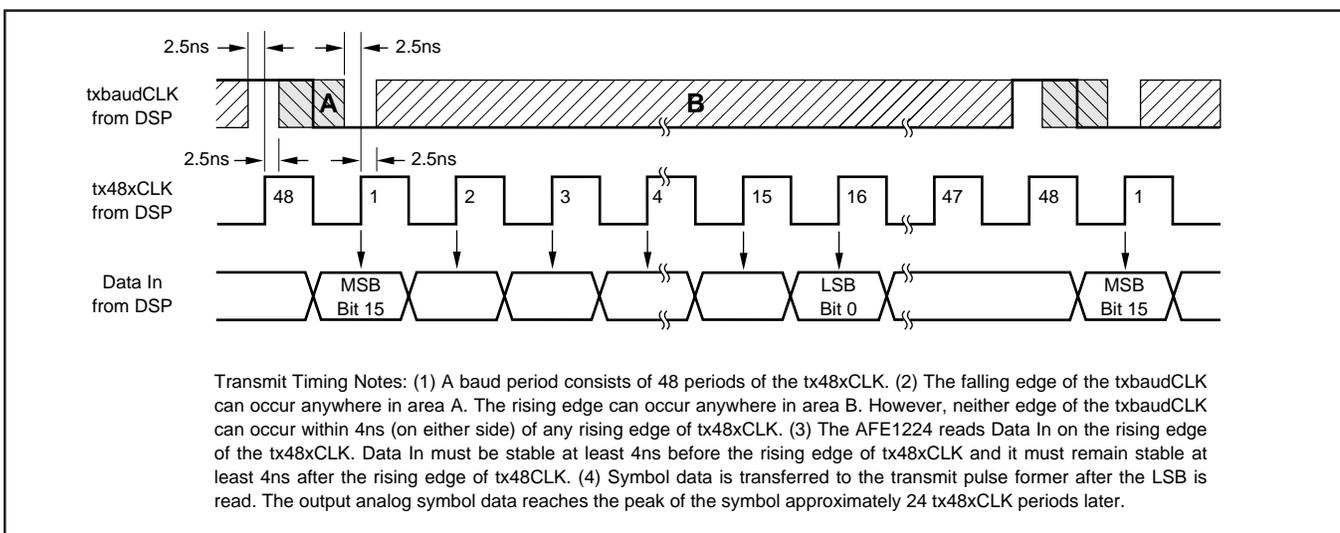


FIGURE 2. Transmit Timing Diagram.

received in the first 16 bits of each baud period. The remaining 32-bit periods are not used for Data In. Data Out is transmitted during the first 16 bits of the baud period. A second interpolated value is transmitted in subsequent bits of the baud period.

txbaudCLK: The transmit data baud rate, generated by the DSP. It is 784kHz for T1 or 1168kHz for E1. It may vary from 32kHz (64kbps) to 1168Hz (2.320Mbps).

tx48xCLK: The transmit pulse former oversampling sampling clock, generated by the DSP. It is 48x the transmit symbol rate or 56.064MHz for 1168kHz symbol rate. This clock should run continuously.

Data In: This is a 16-bit output data word sent from the DSP to the AFE. The sixteen bits include tx symbol information and other control bits, as described below. The data should be clocked out of the DSP on the falling edge and should be

valid on the rising edge of the tx48xCLK. The AFE1224 reads Data In on the rising edge of the tx48xCLK. The bits are defined in Table I. Data In is read by the AFE1224 during the first 16 bits periods of each baud period. Only the first 8 bits are used in the AFE1224. The second 8 bits are reserved for use in the future products. The remaining 32 bits periods of the baud period are not used for Data In.

Data In Bits

tx enable signal—This bit controls the tx Symbol definition bits. If this bit is 0, only a 0 symbol is transmitted regardless of the state of the tx Symbol definition bits. If this bit is 1, the tx Symbol definition bits determine the output symbol.

tx Symbol Definition—These two bits determine the output 2B1Q symbol transmitted.

Rx Gain Settings—These bits set the gain of the receive channel programmable gain amplifier.

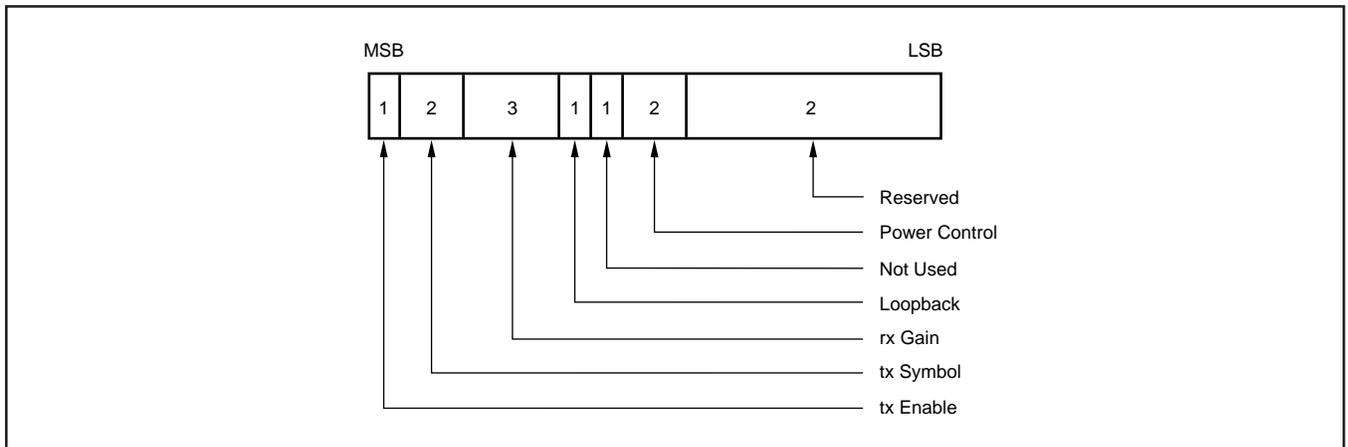


FIGURE 3. Data In Word.

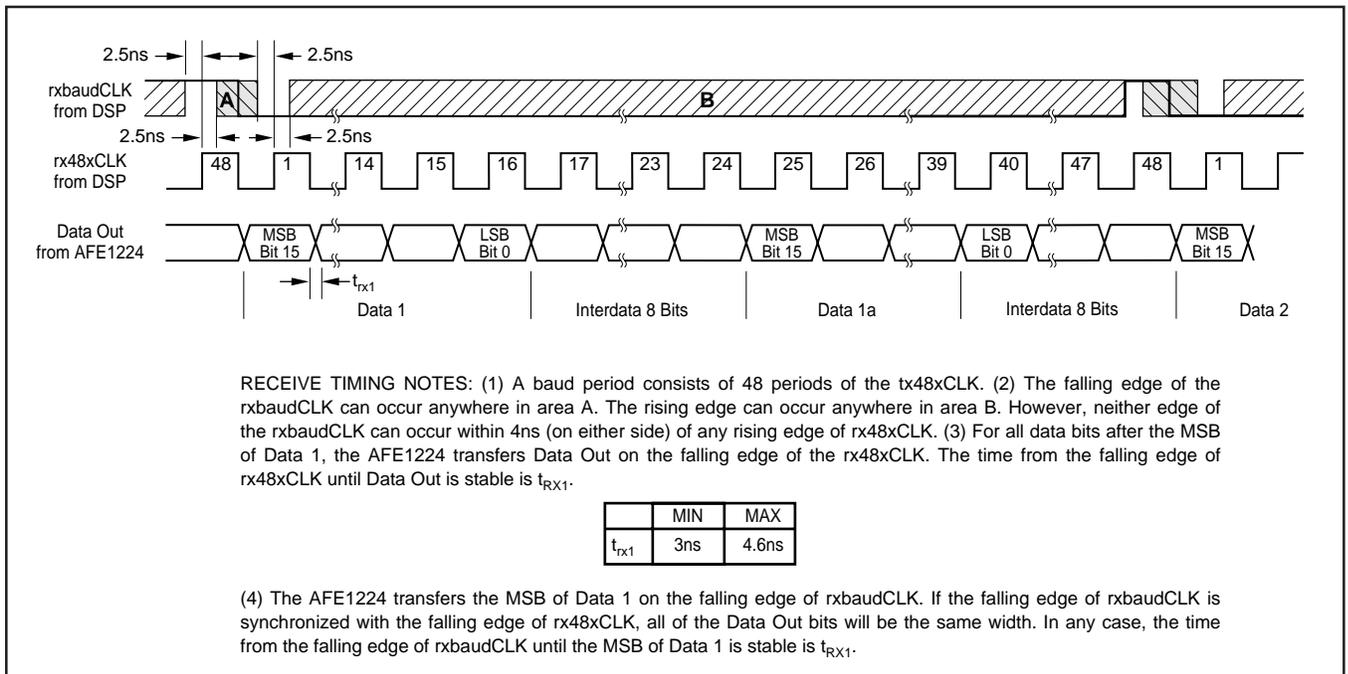


FIGURE 4. Receive Timing Diagram.

Loopback Control—This bit controls the operation of loopback. When enabled (logic 1), the rxLINE+ and rxline- inputs are disconnected from the AFE. The rxHYB+ and rxHYB- inputs remain connected. When disabled, the rxLINE+ and rxLINE- inputs are connected.

Power Control—These bits control the power dissipation and the maximum speed of the AFE1224.

BIT	DESCRIPTION	BIT STATE	OUTPUT STATE
15 (MSB)	tx Enable Signal	0	AFE transmits a 0 Symbol
		1	AFE transmits HDSL Symbol as defined by bits 14 and 13
14 and 13	tx Symbol Definition	00	-3 transmit symbol
		01	-1 transmit symbol
		11	+1 transmit symbol
		10	+3 transmit symbol
12 - 10	rx Gain Settings	000	rx gain in AFE 0dB
		001	rx gain in AFE 3dB
		010	rx gain in AFE 6dB
		011	rx gain in AFE 9dB
		100	rx gain in AFE 12dB
		101	rx gain in AFE reserved
		110	rx gain in AFE reserved
		111	rx gain in AFE reserved
9	Loopback Control	1	Go to loopback mode
		0	Normal Operation
8	Not Used		N/A
7-6	Power Control	00	Low speed, low power
		01	Medium Speed, power
		10	Normal Speed, power
		11	Normal Speed, power
5-0	Spare		N/A

TABLE I. Data Input Format.

rxbaudCLK: This is the receive data baud rate (symbol clock), generated by the DSP. It is 392kHz for T1 or 584kHz for E1. It can vary from 32kHz (64kbps) to 584kHz (1.168Mbps).

rx48xCLK: This is the A/D converter over-sampling clock, generated by the DSP. It is 48x the receive symbol rate or 28.032MHz for 584kHz symbol rate. This clock should run continuously.

Data Out: This is the 14-bit A/D converter output data (+ 2 spare bits) sent from the AFE to the DSP. The 14 bits from the A/D Converter will be the upper bits of the 16-bit word (bits 15-2). The spare bits (1 and 0) will be always be LOW. Eight additional bits follow which are always HIGH. The data is clocked out on the falling edge and valid at the rising edge of the rx48xCLK. The bandwidth of the A/D converter decimation filter is equal to one-half of the symbol rate. The nominal output rate of the A/D converter is one conversion per symbol period. For more flexible post-processing, there is a second true A/D conversion available in each symbol period. In Figure 4, the first conversion is shown as Data 1 and the second conversion is shown as Data 1a. It is recommended that rxbaudCLK be used with the rx48xCLK to read Data 1 while Data 1a is ignored. However, either data output may be used and both outputs may be used for more flexible post-processing.

DATA OUT PER SYMBOL PERIOD

DATA	BITS
Data 1	16
Interdata Bits	8
Data 1a	16
Interdata bits	8
Total Bits/Symbol Period	48

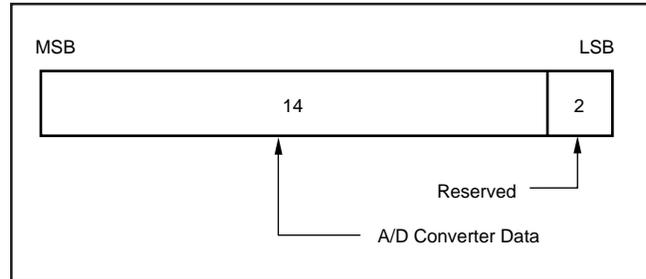


FIGURE 5. Data Out Word.

ANALOG-TO-DIGITAL CONVERTER DATA

The A/D converter data from the receive channel is coded in Binary Two's Complement.

ANALOG INPUT	A/D CONVERTER DATA	
	MSB	LSB
Positive Full Scale	01111111111111	
Mid Scale	00000000000000	
Negative Full Scale	10000000000000	

TABLE II. Data Output Format.

ECHO CANCELLATION IN THE AFE

The rxHYB input is subtracted from the rxLINE input for first order echo cancellation. For correct operation, be certain that the rxLINE input is connected to the same polarity signal at the transformer (+ to + and - to -) while the rxHYB input is connected to opposite polarity through the compromise hybrid (- to + and + to -). Refer to the basic connection diagram in Figure 6.

SCALEABLE TIMING

The AFE1224 scales operation with the clock frequency. All internal filters and the pulse former change frequency with the clock speed so that the unit can be used at different frequencies just by changing the clock speed.

For the receive channel, the digital filtering of the delta-sigma converter scales directly with the clock speed. The bandwidth of the converter's decimation filter is always one-half of the symbol rate. The only receive channel issue in changing baud rate is the passive single pole anti-alias filter (see the following section). For systems implementing a broad range of speeds, selectable cut-off frequencies for the passive anti-alias filter should be used.

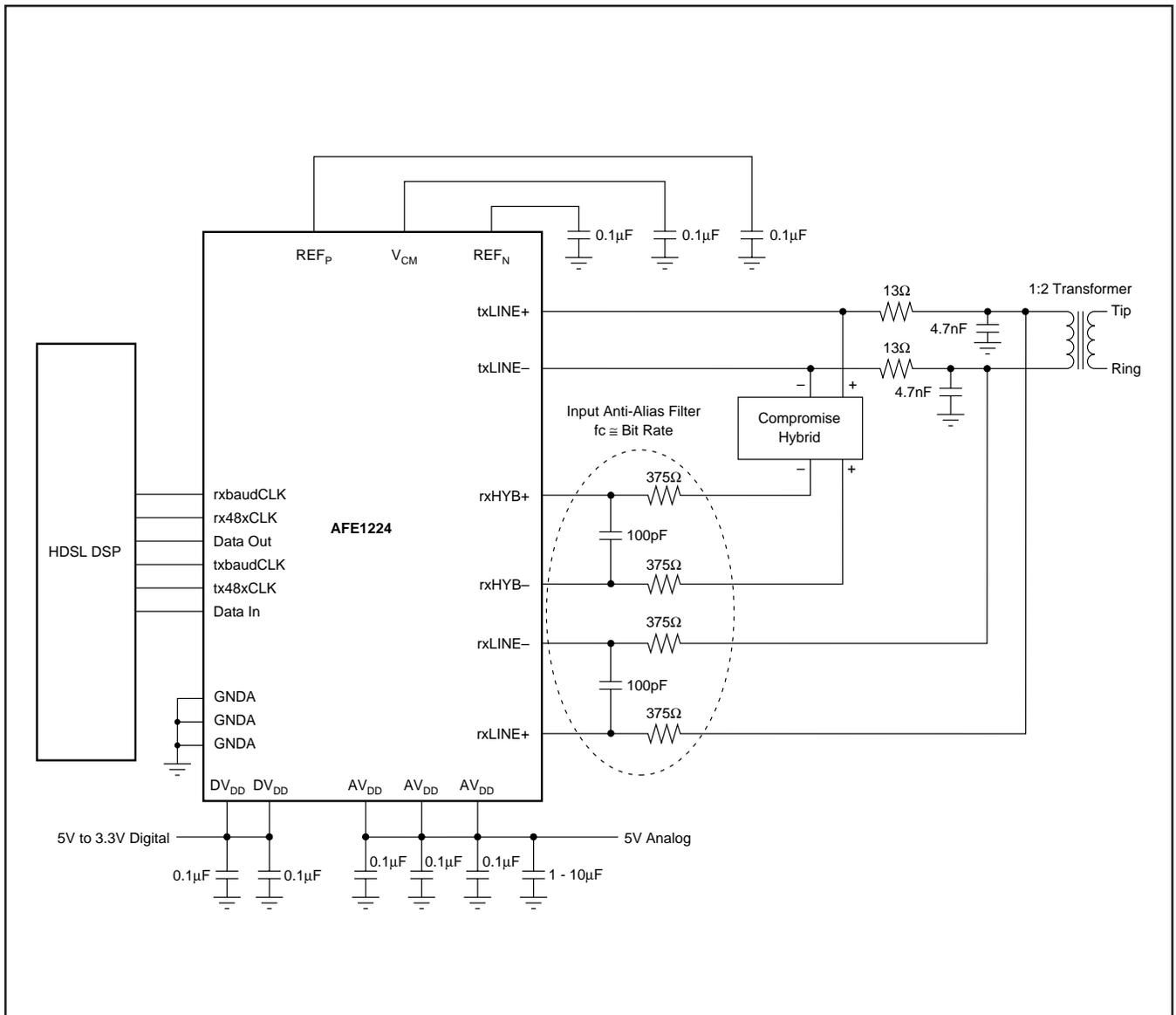


FIGURE 6. Basic Connection Diagram.

For the transmit channel, the pulse shape and the power spectral density scale directly with the clock rate. The power spectral density shown in Curve 1 and the pulse template shown in Curve 2 are measured at the output of the transformer. The transformer and the RC circuit on the output provide some smoothing for the output transmission. At lower bit rates, the amount of smoothing will be less and more output filtering may be needed.

rxHYB AND rxLINE INPUT ANTI-ALIASING FILTERS

An external input anti-aliasing filter is needed on the hybrid and line inputs as shown in the basic connection diagram (Figure 6). The -3dB frequency of the input anti-aliasing

filter for the rxLINE and rxHYB differential inputs should be approximately 2MHz for single pair T1 and E1 symbol rates. Suggested values for the filter are 375Ω for each of the two input resistors and 100pF for the capacitor. Together the two 375Ω resistors and the 100pF capacitor result in a 3dB frequency of just over 2MHz . The 375Ω input resistors will result in minimal voltage divider loss with the input impedance of the AFE1224. This circuit applies at rates of 1Mbps to 2Mbps . For slower rates, the anti-aliasing filters will give best performance with 3dB frequency approximately equal to the bit rate. For instance, a 3dB frequency of 320kHz may be used for a single line bit rate of 320k bits per second.

DISCUSSION OF SPECIFICATIONS

UNCANCELLED ECHO

A key measure of transceiver performance is uncanceled echo. Uncanceled echo is the summation of all of the errors in the transmit and receive paths of the AFE1224. It includes effects of linearity, distortion and noise. Uncanceled echo is tested in production by Burr-Brown with a circuit that is similar to the one shown in Figure 7, Uncanceled Echo Test Diagram.

The measurement of uncanceled echo is made as follows:

The AFE is connected to an output circuit including a typical 1:2 line transformer. The line is simulated by a 135Ω resistor. Symbol sequences are generated by the tester and applied both to the AFE and to the input of an adaptive filter. The output of the adaptive filter is subtracted from the AFE output to form the uncanceled echo signal. Once the filter taps have converged, the rms value of the uncanceled echo is calculated. Since there is no far-end signal source or additive line noise, the uncanceled echo contains only noise and linearity errors generated in the transmit and receive sections of the AFE1224.

The data sheet value for uncanceled echo is the ratio of the rms uncanceled echo (referred to the receiver input through the receiver gain) to the nominal transmitted signal (13.5dBm into 135Ω, or 1.74Vrms). This echo value is measured under a variety of conditions: with loopback enabled (line input disconnected); with loopback disabled under all receiver gain ranges; and with the line shorted (S_1 closed, see Figure 7).

POWER DISSIPATION

The power dissipation of the AFE1224 is digitally programmable by the user to three levels: normal, medium and low. The maximum bit rate of the AFE1205 is 2.3Mbps with normal power dissipation. At lower power dissipation levels, the maximum bit rate is lower.

The power dissipation listed in the Specifications Table applies under these normal operating conditions: 5V analog power supply, 3.3V digital power supply, standard 13.5dBm delivered to the line, and a pseudo-random equiprobable sequence of HDSL output pulses. The power dissipation specifications includes all power dissipated in the AFE1224, but it does not include power dissipated in the external load.

The external power is 16.5dBm: 13.5dBm to the line and 13.5dBm to the impedance matching resistors. The external load power of 16.5dBm is 45mW. The typical power dissipation in the AFE1224 under various conditions is shown in Table III.

POWER LEVEL	MAXIMUM SPEED	MINIMUM SPEED	TYPICAL POWER DISSIPATION
Normal	2.3Mbps	64kbps	385mW
Medium	1.168Mbps	64kbps	300mW
Low	320kbps	64kbps	240mW

TABLE III. Typical Power Dissipation.

LAYOUT

The analog front end of an HDSL system has two conflicting requirements. It must accept and deliver moderately high rate digital signals and it must generate, drive, and convert precision analog signals. To achieve optimal system performance with the AFE1224, both the digital and the analog sections must be treated carefully in board layout design.

The power supply for the digital section of the AFE1224 can range from 3.3V to 5V. This supply should be decoupled to digital ground with ceramic 0.1μF capacitors placed as close to DGND and DV_{DD} as possible. One capacitor should be placed between pins 3 and 4 and the second capacitor between pins 11 and 12. Ideally, both a digital power supply plane and a digital ground plane should run up to and underneath the digital pins of the AFE1224 (pins 5 through 10). However, DV_{DD} may be supplied by a wide printed circuit board (PCB) trace. A digital ground plane underneath all digital pins is strongly recommended.

The remaining portion of the AFE1224 should be considered analog. All AGND pins should be connected directly to a common analog ground plane and all AV_{DD} pins should be connected to an analog 5V power plane. Both of these planes should have a low impedance path to the power supply. The analog power supply pins should be decoupled to analog ground with ceramic 0.1μF capacitors placed as close to the AFE1224 as possible. One 10μF tantalum capacitor should also be used with each AFE1224 between the analog supply and analog ground.

Ideally, all ground planes and traces and all power planes and traces should return to the power supply connector before being connected together (if necessary). Each ground and power pair should be routed over each other, should not overlap any portion of another pair, and the pairs should be separated by a distance of at least 0.25 inch (6mm). One exception is that the digital and analog ground planes should be connected together underneath the AFE1224 by a small trace.

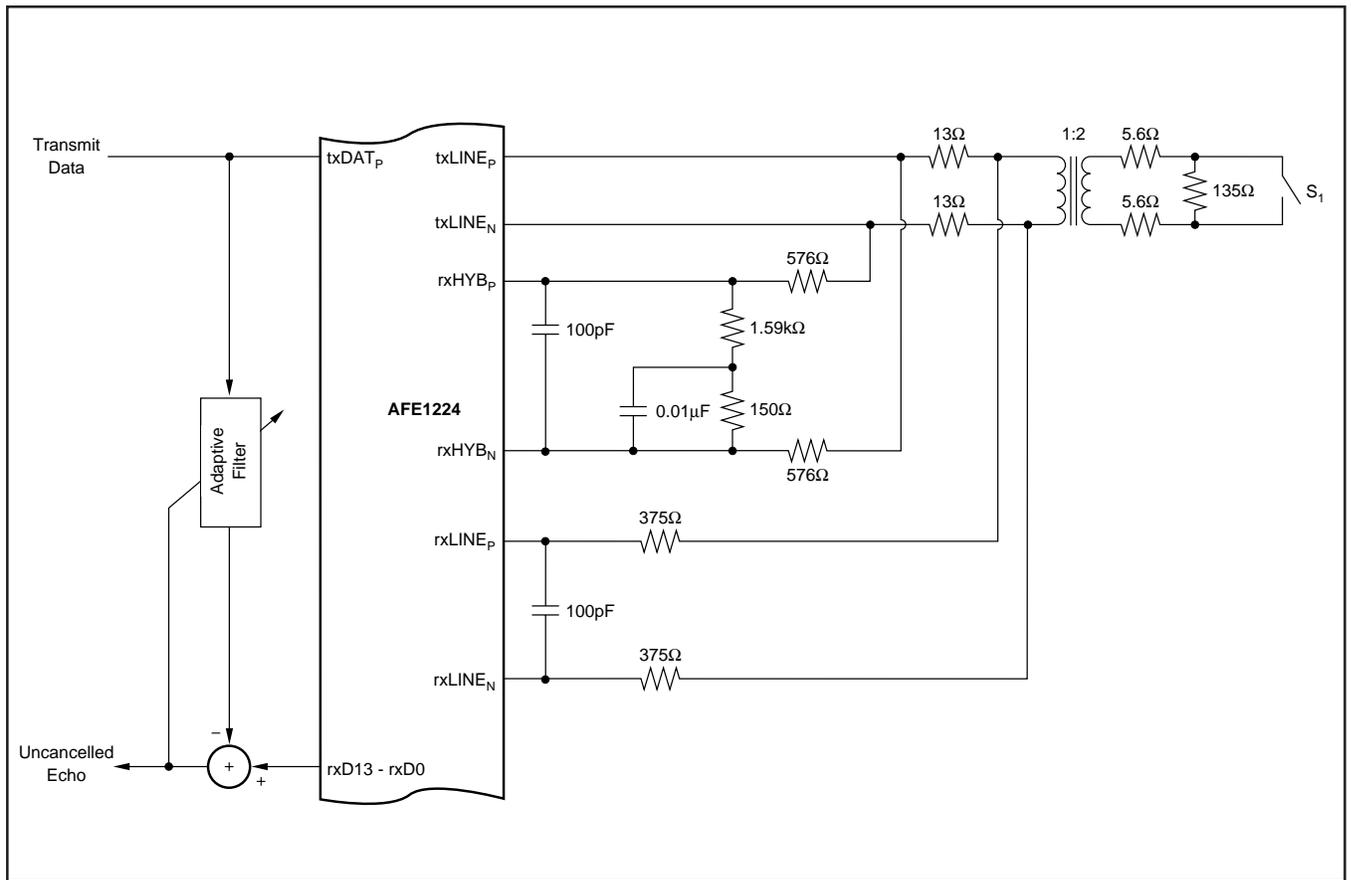


FIGURE 7. Uncancelled Echo Test Diagram.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
AFE1224E-2/1K	OBSOLETE	SSOP	DB	28		TBD	Call TI	Call TI
AFE1224E-2/1KG4	OBSOLETE	SSOP	DB	28		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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